



#### **DUAL P-CHANNEL ENHANCEMENT MODE MOSFET**

### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub> max T <sub>A</sub> = +25°C
-20V	$75mΩ @ V_{GS} = -4.5V$	-4.6A
-20V	110mΩ @ V <sub>GS</sub> = -2.5V	-2.9A

### **Description**

This MOSFET has been designed to minimize the on-state resistance and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

### **Applications**

- Backlighting
- Power Management Functions
- DC-DC Converters

### **Features**

- Low On-Resistance
- Low Input Capacitance
- · Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 standards for High Reliability

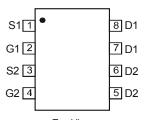
### **Mechanical Data**

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Marking Information: See Page 4
- Ordering Information: See Page 4
- Weight: 0.072 grams (approximate)

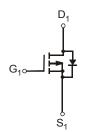
SO-8



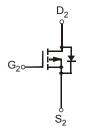
Top View



Top View Internal Schematic



P-Channel MOSFET



P-Channel MOSFET

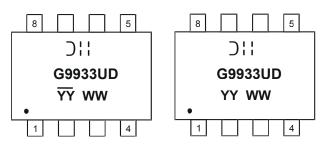
### Ordering Information (Note 4)

Part Number	Case	Packaging
DMG9933USD-13	SO-8	2,500 / Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

### **Marking Information**



Shanghai A/T Site

⊃¦¦ = Manufacturer's Marking
 G9933UD = Product Type Marking Code
 YYWW = Date Code Marking
 YY or YY = Year (ex: 14 = 2014)
 WW = Week (01 - 53)

 $\frac{\text{YY}}{\text{YY}}$  = Date Code Marking for SAT (Shanghai Assembly/ Test site)  $\frac{\text{YY}}{\text{YY}}$  = Date Code Marking for CAT (Chengdu Assembly/ Test site)

Chengdu A/T Site



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	-20	V		
Gate-Source Voltage	V <sub>GSS</sub>	±12	V		
Continuous Drain Current (Note 5) V <sub>GS</sub> = -4.5V	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +85°C	I <sub>D</sub>	-4.6 -3	А
Pulsed Drain Current (Note 6)			I <sub>DM</sub>	-20	Α

# Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P <sub>D</sub>	1.15	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C	$R_{\theta JA}$	109	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

Notes:

- 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.
- 6. Repetitive rating, pulse width limited by junction temperature.

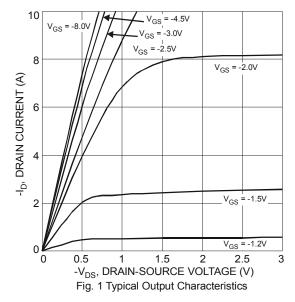
### **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

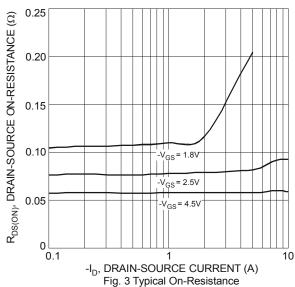
Characteristic	Symbol	Min	Turn	May	I I mid	Test Condition	
OFF CHARACTERISTICS (Note 7)		Min	Тур	Max	Unit	rest Condition	
, ,	5)/	- 00	1	l		N/ 01/ 1 050 A	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-20	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	I <sub>DSS</sub>	_	_	-1	μΑ	$V_{DS} = -16V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	$V_{GS(th)}$	-0.45		-1.1	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
Static Dunin Source On Bosistanes		_	55	75	mΩ	$V_{GS} = -4.5V$ , $I_D = -4.8A$	
Static Drain-Source On-Resistance	R <sub>DS (ON)</sub>	_	76	110		V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -1A	
Forward Transfer Admittance	Y <sub>fs</sub>	_	10	_	S	$V_{DS} = -9V, I_{D} = -3.4A$	
Diode Forward Voltage	$V_{SD}$	_	-0.8	-1.2	V	$V_{GS} = 0V, I_{S} = -2A$	
DYNAMIC CHARACTERISTICS (Note 8)	_	_	_	_	_		
Input Capacitance	C <sub>iss</sub>	_	608.4	_	pF	.,	
Output Capacitance	Coss	_	81.5	_	pF	$V_{DS} = -6V, V_{GS} = 0V$ - f = 1MHz	
Reverse Transfer Capacitance	C <sub>rss</sub>	_	72.4	_	pF	71 - 1101112	
Gate Resistance	$R_{g}$	_	44.91	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge	Qg	_	6.5	_	nC	V <sub>DS</sub> = -10V, V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -3.2A	
Gate-Source Charge	$Q_{gs}$		0.9	_	nC		
Gate-Drain Charge	$Q_{gd}$	_	1.5	_	nC	ID3.2A	
Turn-On Delay Time	t <sub>D(on)</sub>	_	12.45	_	ns		
Turn-On Rise Time	t <sub>r</sub>	_	10.29	_	ns	$V_{DS}$ = -10V, $V_{GS}$ = -4.5V, $R_L$ = 10 $\Omega$ , $R_G$ = 1 $\Omega$ , $I_D$ = -1A	
Turn-Off Delay Time	$t_{D(off)}$	_	46.52	_	ns		
Turn-Off Fall Time	t <sub>f</sub>	_	22.19	_	ns		

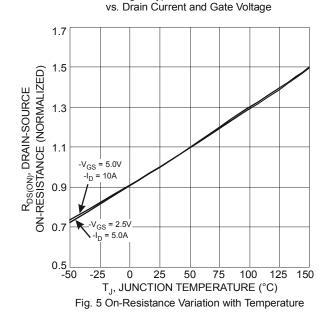
Notes:

- 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to production testing.









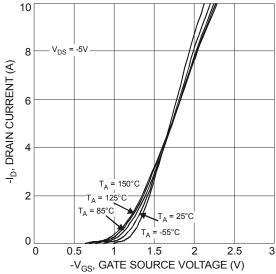


Fig. 2 Typical Transfer Characteristics

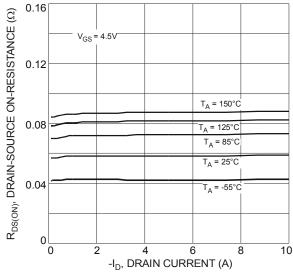


Fig. 4 Typical Drain-Source On-Resistance vs. Drain Current and Temperature

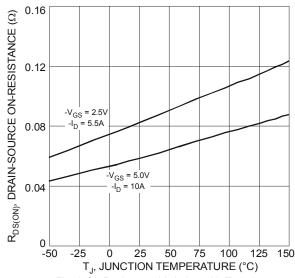


Fig. 6 On-Resistance Variation with Temperature



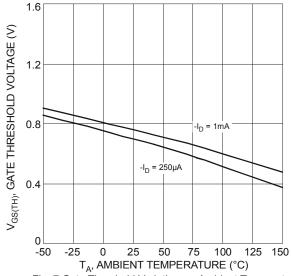
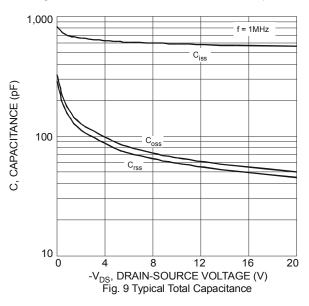
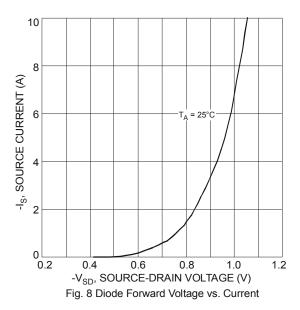
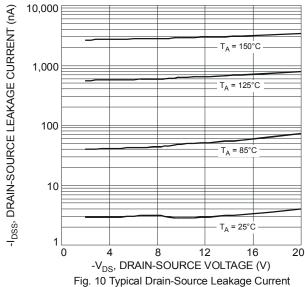


Fig. 7 Gate Threshold Variation vs. Ambient Temperature







vs. Drain-Source Voltage

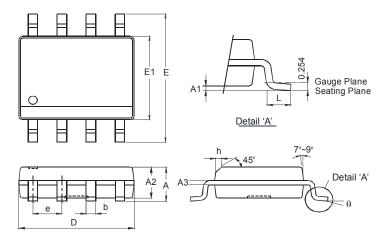
r(t), TRANSIENT THERMAL RESISTANCE  $R_{\theta JA}(t) = r(t) * R_{\theta JA}$   $R_{\theta JA} = 156^{\circ}C/W$ D = 0.020.01 t<sub>2</sub> D = 0.005  $T_J - T_A = P * R_{\theta JA}(t)$ Duty Cycle, D =  $t_1/t_2$ 0.001 0.0001 0.001 0.1 10 100 1,000 t<sub>1</sub>, PULSE DURATION TIME (s)

Fig. 11 Transient Thermal Response



## **Package Outline Dimensions**

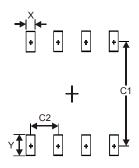
Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



SO-8				
Dim	Min	Max		
Α	ı	1.75		
A1	0.10	0.20		
A2	1.30	1.50		
A3	0.15	0.25		
b	0.3	0.5		
D	4.85	4.95		
Е	5.90	6.10		
E1	3.85	3.95		
е	1.27 Typ			
h	1	0.35		
L	0.62	0.82		
θ	0°	8°		
All Dimensions in mm				

## **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Х	0.60
Υ	1.55
C1	5.4
C2	1.27



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